Design Idea DI-23 **TOPSwitch[®]-GX** 10 W, Multi-output, High Speed Modem Power Supply



Application	Device	Power Output	Input Voltage	Output Voltage	Topology
High Speed Modem	TOP243P	10 W	85-264 VAC	3.3 V / 5 V / 30 V	Flyback

Design Highlights

- Compact low cost design (113 mm × 39 mm × 25 mm) with only 46 parts
- Meets Blue Angel no-load power consumption
- Line undervoltage protection prevents turn-off output glitches and overvoltage protection provides extended line surge protection
- Hysteretic thermal shutdown provides automatic fault recovery
- Frequency jittering dramatically reduces EMI and meets EN550022 Class B without Y1 capacitor
- Ultra low leakage current (<1 µA at 265 VAC) eliminates audio hum in voice applications
- Surge immunity to 4 kV (EN61000-4-5)
- High efficiency >70%

Operation

TOP243P (DIP package) is shown in Figure 1. The power supply utilizes many *TOPSwitch-GX* features such as frequency jittering, input voltage sense, thermal shutdown, internal current limit, soft-start, etc. without adding any extra components.

Typical applications are wall mount adapters, set-top box, highspeed modem, standby power supplies, and other applications requiring very low cost, small size, and low no-load input power consumption.

The example discussed here passes EMI conducted and radiated emissions tests without using a Y1 capacitor between primary and secondary. This is possible with the frequency jittering feature of *TOPSwitch-GX* and careful transformer construction. Shield windings are used in the transformer to reduce common mode EMI currents. Transformer specifications are given in Table 1.

Good cross-regulation of output voltages is achieved by careful transformer construction and using a TL431 voltage regulator instead of a Zener regulator.

The power supply uses a low cost RCD clamp with a slow 1N4007GP diode, which reduces EMI emissions and recycles leakage energy, increasing efficiency. Input line sensing prevents reverse conduction of current in *TOPSwitch-GX* at very low input voltages due to the 1N4007GP in the RCD clamp.



Figure 1. TOP243P - 10 W, 3.3 V at 1.5 A, 5 V at 0.9 A, 30 V at 0.03 A, High Speed Modem Power Supply.

Key Design Points

- Use K_{RP} (Ripple-to-peak current ratio) in the range of 0.4–0.6 for better efficiency.
- Select V_{OR} (reflected output voltage) of 90 V to 110 V for optimum performance.
- Opto with CTR range of 80% to 160% recommended.
- PCB traces which carry high switching voltages and current should be short and wide to reduce EMI.

TRANSFORMER PARAMETERS							
Core Material	EE25, Nippon Ceramic NC-2H or equivalent, A _{LG} = 351 nH/T ²						
Bobbin	YW-360-02B, YIH-HWA, 10 pin Vertical						
Winding Details	Shield: 15T, 2 x 29 AWG Primary: 49T, 27 AWG Bias: 7T, 3 x 28 AWG 3.3 V: 2T, 3 x 26 AWG T.I.W. 5 V: 1T, 26 AWG T.I.W. 30 V: 13T, 26 AWG T.I.W. (T.I.W. = Triple Insulated Wire)						
Winding Order (Pin Numbers)	Shield (1-NC), 3 x tape, Primary (2-1), with tape between layers, tape, Bias (5-4), 6 x tape, 3.3 V (6-7), tape, 5 V (9-6), tape, 30 V (10-9), 2 x tape, Shield (1-3), 3 x tape						
Inductance	Primary: 1 mH ±10%, Leakge: 30 μH (maximum)						
Primary Resonant Frequency	500 kHz (minimum)						

Table 1. Transformer Construction Information.

- Reduce leakage inductance and improve cross-regulation by filling each winding layer across the entire width of the bobbin.
- Use shield windings to improve EMI.
- Use a layer of insulation tape between layers of primary winding to reduce inter-winding capacitance.
- D5 should be a GP type (glass passivated) to ensure a controlled reverse recovery time.

vo	Load Range		Regulation (%)																	
	(Amp)	-8	-7	-6	-5	-4	-3	-2	-1	0	1	2	3	4	5	6	7	8	9	10
3.3	0.3-1.5																			Π
5	0.3-0.9		Π								Γ									
30	0.01-0.03		П	П					П	ГГ	П	П			ГГ				Г	

Table 2. Worst Case Output Cross-Regulation - Outputs Taken from Minimum to Maximum Load.



Figure 2. Conducted Emissions – EN55022 Class B (QP and AV), 230 VAC, Full Load, Artificial Hand Connected to Secondary Return.

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